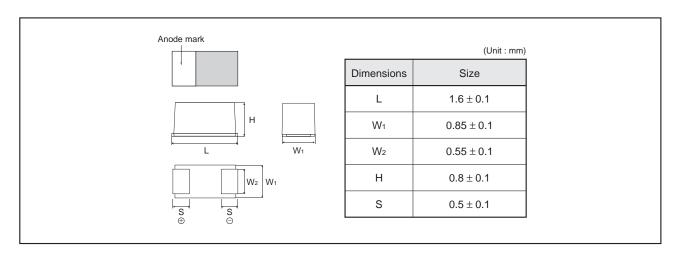
Chip tantalum capacitors (Bottom surface electrode type : Large capacitance)

TC Series M Case Datasheet

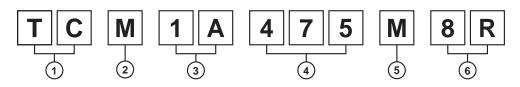
Features

- 1) Bottom electrode configuration results in significantly greater compactness.
- 2) Filet formation enables easy visibility after mounting.
- 3) Ideal for noise removal on power supply lines with limited space.
- 4) Eco-friendly halogen-free products.

Dimensions



●Part No. Explanation



1 Series name

TC

2 Case style

M: 1608-09 (0603) size

3 Rated voltage

Rated voltage (V)	l	1	l				
CODE	0E	0G	0J	1A	1C	1D	1E

(4) Nominal capacitance

Nominal capacitance in pF in 3 digits: 2 significant figures followed by the figure representing the number of 0's.

(5) Capacitance tolerance

M: ±20%

6 Taping

8: Tape width

R : Positive electrode on the side opposite to sprocket hole

^{*}This specification has possibility of charge, due to underdevelopment product. Please ask for latest specification to our sales.

TC Series M Case Datasheet

●Rated table

Capacitance			Ra	ted voltage (V.Do	C)		
(μF)	2.5	4	6.3	10	16	20	25
1.0 (105)				М	М		М
1.5 (155)							
2.2 (225)				М	М	☆M	
3.3 (335)							
4.7 (475)			М	М	☆M		
10 (106)		М	М	М			
15 (156)							
22 (226)		М	М				
33 (336)		М	М				
47 (476)	М						

Remark) Case size codes (M) in the above show products line-up.

Marking

The indications listed below should be given on the surface of a capacitor.

(1) Polarity : The polarity should be shown by \square bar. (on the anode side) (2) Rated DC voltage : A voltage code is shown as below table.

(3) Capacitance : A capacitance code is shown as below table.

Voltage Code	Rated DC Voltage (V)
е	2.5
g	4
j	6.3
А	10
С	16
D	20
Е	25

Capacitance Code	Nominal Capacitance (μF)
А	1.0
Е	1.5
J	2.2
N	3.3
S	4.7
а	10
е	15
j	22
n	33
S	47

Visual typical example

voltage code and capacitance code are variable with parts number.

[M case]

EX.)

$$\frac{A}{(1)}$$
 $\frac{s}{(2)}$

(1) voltage code

(2) capacitance code



TC Series M Case

● Characteristics

Iter	n					Pe	Performance				nditions	(base	d on JIS C 510°	1-1 and JIS C 5101-3)	
Operating Temp		-55	5°C t	0 +	125°	°C			Volta	ige r	duction	when	temperature ex	ceeds +85°C	
Maximum operatemperature wit derating	ating h no voltage	+85	5°C												
Rated voltage ('	V.DC)	2.5	4	6.3	10	16	20	25	at 85	°C					
Category voltage (V.DC) 1.6 2.5 4 6.3 10 13 16			at 12	5°C											
Surge voltage (V.DC) 3.2 5.2 8 13 20 26 32			32	at 85	°C										
DC Leakage cu	rrent		all be anda				he v	alue on	As p	er 4.	JIS C 5 .1 JIS C Rated vo	5101			
Capacitance tol	erance	Sha ±20		sa	tisfie	ed a	allow	ance range.	As po Meas Meas	er 4. surin surin	JIS C 5 .2 JIS C frequer voltage	5101 ncy:1			
Tangent of loss angle (Df, $\tan\delta$) Shall be satisfied the value on " Standard list "						As po	As per 4.8 JIS C 5101-1 As per 4.5.3 JIS C 5101-3 Measuring frequency: 120±12Hz Measuring voltage: 0.5Vrms +1.5.DC Measuring circuit: DC Equivalent series circuit								
Impedance Shall be satisfied the value on "Standard list"				As po Meas Meas	As per 4.10 JIS C 5101-1 As per 4.5.4 JIS C 5101-3 Measuring frequency: 100±10kHz Measuring voltage: 0.5Vrms or less Measuring circuit: DC Equivalent series circuit										
Resistance to Soldering heat	Appearance		There should be no significant abnormality. The indications should be clear.				As p	As per 4.14 JIS C 5101-1 As per 4.6 JIS C 5101-3							
	L.C.	Les	s th	an 2	2009	% o	f initi	al limit		Dip in the solder bath Solder temp : 260±5°C Duration : 5±0.5s Repetition : 1 After the specimens, leave it at room temperature for					
	⊿C/C	TCI Oth		3361	M8R			n ±30% of initial valu n ±20% of initial valu	e. Rep						
	Df (tan δ)	Les	ss th	an 2	2009	% o	f init	al limit		over 24h and then measure the sample.					
Temperature cycle	Appearance							nificant abnormality be clear.	As p	er 4.	6 JIS C 0 JIS C	5101-			
	L.C.	Les	ss th	an 2	2009	% o	f init	al limit			: 5 cyclesteps 1 t		rithout discontin	uation.	
	⊿C/C	TCI	MOJ	3361	M8R	2 : V	Vithir	±30% of initial valu	─ ` ′		Tem		Time		
		Oth						±20% of initial valu		1	-55±3	•	30±3min.		
	Df (tan δ)	Les	s th	an 2	2009	% o	f init	al limit		2	Room to	emp.	3min.or less		
										3	125±2	2°C	30±3min.		
										4	Room to		3min.or less		
													ive it at room te sure the sample		
Moisture resistance	Appearance	There should be no significant abnormality. The indications should be clear.			As p	As per 4.22 JIS C 5101-1 As per 4.12 JIS C 5101-3									
	L.C.	Les	s th	an 2	2009	% o	f init	al limit	After leaving the sample under such atmospheric condition that the temperature and humidity are				•		
	⊿C/C	TCI Oth		3361	M8R			n ±30% of initial valu n ±20% of initial valu	e. 60±2 e. leave	°C a	nd 90 to room	95% F	RH,respectiveiy	, for 500±12h	
	Df (tan δ)	Les	s th	an 2	2009	% o	f init	al limit		leave it at room temperature for over 24h and then measure the sample.					



Iten	n	Performance	Test conditions (based on JIS C 5101–1 and JIS C 5101–3)						
Temperature Stability	Temp.	−55°C	As per 4.29 JIS C 5101-1 As per 4.13 JIS C 5101-3						
Cidoliniy	⊿C/C	TCM0G336M8R: Within 0/-30% of initial value TCM0J226M8R: Within 0/-30% of initial value TCM0J336M8R: Within 0/-30% of initial value Others: Within 0/-15% of initial value							
	Df (tan δ)	Shall be satisfied the voltage on " Standard list "							
	L.C.	_							
	Temp.	+85°C							
	⊿C/C	TCM0G336M8R: Within +15/-5% of initial value TCM0J226M8R: Within ±15/-5% of initial value TCM0J336M8R: Within ±15/-5% of initial value Others: Within +15/0% of initial value							
	Df (tan δ)	Shall be satisfied the voltage on " Standard list "							
	L.C.	Less than 1000% of initial value							
	Temp.	+125°C							
	⊿C/C	TCM0G336M8R : Within +20/–5% of initial value Others : Within +20/0% of initial value							
	Df (tan δ)	Shall be satisfied the voltage on " Standard list "							
	L.C.	Less than 1250% of initial value							
Surge voltage	Appearance	There should be no significant abnormality.	As per 4.26JIS C 5101-1						
	L.C.	Less than 200% of initial limit	As per 4.14JIS C 5101-3 Apply the specified surge voltage every 5±0.5 min.						
	⊿C/C	Within ±20% of initial value	for 30±5 s. each time in the atmospheric condition of 85±2°C. Repeat this procedure 1,000 times.						
	Df (tan δ)	Less than 200% of initial limit	After the specimens, leave it at room temperature for over 24h and then measure the sample.						
Loading at High temperature	Appearance	There should be no significant abnormality.	As per 4.23 JIS C 5101-1						
riigii terriperature	L.C.	Less than 200% of initial limit	As per 4.15 JIS C 5101-3 After applying the rated voltage for 1000+36/0 h without						
	△C / C TCM0G336M8R: Within ±30% of initial value TCM0J226M8R: Within ±30% of initial value TCM0J336M8R: Within ±30% of initial value Others: Within ±20% of initial value		discontinuation via the serial resistance of 3Ω or less at a temperature of $85\pm2^{\circ}$ C, leave the sample at room temperature / humidity for over 24h and measure the value.						
	Df (tan δ)	Less than 200% of initial limit							
Terminal	Capacitance	The measured value should be stable.	As per 4.35 JIS C 5101-1						
strength	Appearance There should be no significant abnormality		As per 4.9 JIS C 5101-3 A force is applied to the terminal until it bends to 1mm and by a prescribed tool maintain the condition for 5s. (See the figure below) (Unit: mm) F (Apply force) R230 thickness=1.6mm						

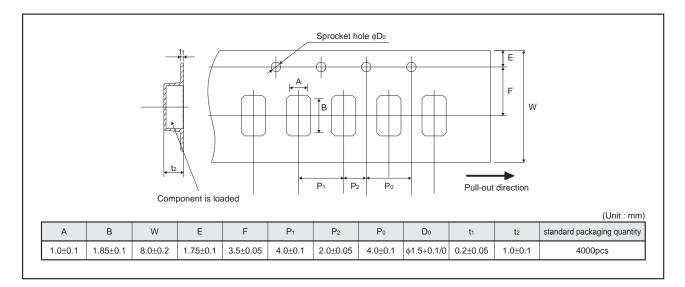
Iten	า	Performance	Test conditions (JIS C 5101-1 and JIS C 5101-3)			
Adhesivenes	S	The terminal should not come off.	As per 4.34 JIS C 5101-1 As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10±1s after mounting the terminal on a circuit board.			
Dimensions		Refer to "External dimensions"	Measure using a caliper of JIS B 7507 Class 2 or higher grade.			
Resistance to	osolvents	The indication should be clear	As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.			
Solderability		3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder.	As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment(accelerated aging): Leave the sample on the boiling distilled water for 1 h. Solder temp.: 245±5°C Duration : 3±0.5s Solder : M705 Flux : Rosin 25% IPA 75%			
Vibration	Capacitance	Measure value should not fluctuate during the measurement.	As per 4.17 JIS C 5101-1 Frequency : 10 to 55 to 10Hz/min. Amplitude : 1.5mm			
Appearance		There should be no significant abnormality.	Time: 2h each in X and Y directions Mounting: The terminal is soldered on a print circuit board.			

Standard products list

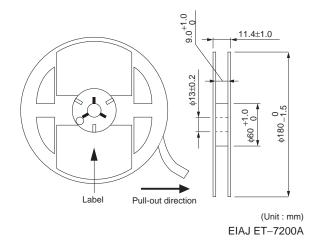
Part No.	Rated voltage 85°C	Category voltage 125°C	Surge voltage 85°C	Cap. 120Hz	Tolerance	Leakage current 25°C		Df 120Hz (%)		Impedance 100kHz
	(V)	(V)	(V)	(μF)	(%)	1WV.300s (μA)	–55°C	25°C 85°C	125°C	(Ω)
TC M 0E 476 M8R	2.5	1.6	3.2	4.7	± 20	0.5	30	20	30	9.0
TC M 0G 106 M8R	4	2.5	5	10	± 20	0.5	30	20	30	9.0
TC M 0G 226 M8R	4	2.5	5	22	± 20	0.9	30	20	30	9.0
TC M 0G 336 M8R	4	2.5	5	33	± 20	13.0	60	30	40	9.0
TC M 0J 475 M8R	6.3	4	8	4.7	± 20	0.5	30	20	30	9.0
TC M 0J 106 M8R	6.3	4	8	10	± 20	0.6	30	20	30	9.0
TC M 0J 226 M8R	6.3	4	8	22	± 20	13.0	60	30	40	9.0
TC M 0J 336 M8R	6.3	4	8	33	± 20	208	60	30	40	9.0
TC M 1A 105 M8R	10	6.3	13	1.0	± 20	0.5	15	10	15	15.0
TC M 1A 225 M8R	10	6.3	13	2.2	± 20	0.5	30	20	30	13.5
TC M 1A 475 M8R	10	6.3	13	4.7	± 20	0.5	30	20	30	9.0
TC M 1A 106 M8R	10	6.3	13	10	± 20	10.0	30	20	30	9.0
TC M 1C 105 M8R	16	10	20	1.0	± 20	0.5	15	10	15	15.0
TC M 1C 225 M8R	16	10	20	2.2	± 20	0.5	30	20	30	13.5
TC M 1E 105 M8R	25	16	32	1.0	± 20	0.5	_	10	_	10

TC Series M Case Datasheet

Packaging specifications



●Reel dimensions



Notice

Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CL ACCIII
CLASSIV	CLASSIII	CLASSⅢ	CLASSIII

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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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Notice-PGA-E Rev.001

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TCM0J106M8R - Web Page

Distribution Inventory

Part Number	TCM0J106M8R
Package	TCM
Unit Quantity	4000
Minimum Package Quantity	4000
Packing Type	Taping
Constitution Materials List	inquiry
RoHS	Yes

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Tantalum Capacitors - Solid SMD category:

Click to view products by ROHM manufacturer:

Other Similar products are found below:

CWR09DC226KBB-TR25 CWR09FC476KB-TR25 CWR09HC106KR-TR25 CWR09HK106KB-TR25 CWR09KC156KP

CWR09MC335KCB CWR09MC335KCB\TR CWR09NC335MM CWR11HC105KB B45197-A2157-M509 B45197A5226M409 NTC
T476K10TRDF NTP337M6.3TRD(18)F CWR06KC106KP CWR09DC476KC-TR25 CWR09FC105KB-TR25 CWR09HC226KB-TR25

CWR09JC685KCA-TR25 CWR09JK105KB-TR25 CWR09JK156MM CWR09KB106KCA CWR09KC106KBC-TR25

CWR09KC106KCB\W CWR09KC156JBB-TR25 CWR11MH685KBA CWR19FC107KBGB CWR19HC226KBFB CWR29JC226KBHC
TR25 TCSCS1A336KBAR B45196-H5106-K309 B45196-H6226-K509 CWR09JC225JBB T83D475K050RCCL TAJB106M016R

TCSCS1A476KBAR T83E107K016RCCL T83D685K035RCCL CWR11JC225KB CWR11HH105KB 293D475X0035B2DE3

F951C106MSAAQ2 293D155X9020A2DE3 CWR29FC106KDBC CWR09NC224KB CWR09NC684KM CWR29HH155KCBB

CWR29HC106KCDC CWR29FC336KDGC CWR09NC225KDB CWR29FC475KDDC